



- Corporate Overview and Organization
- Photonics, Integration and Wafer-Scale Manufacturing
- Interposer Platform & Features
- Product Roadmap
- Market Opportunities



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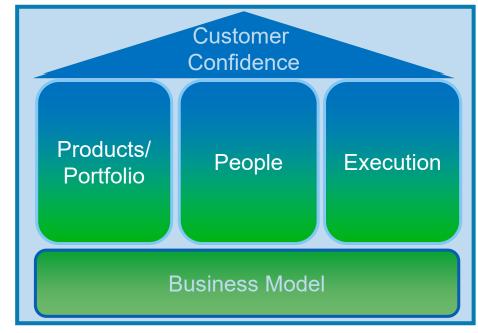


POET's Vision and Mission Statements

Vision: To become the global leader in chipscale integrated photonics solutions by deploying our Optical Interposer technology, enabling seamless integration of electronics and photonics for a broad range of vertical market applications

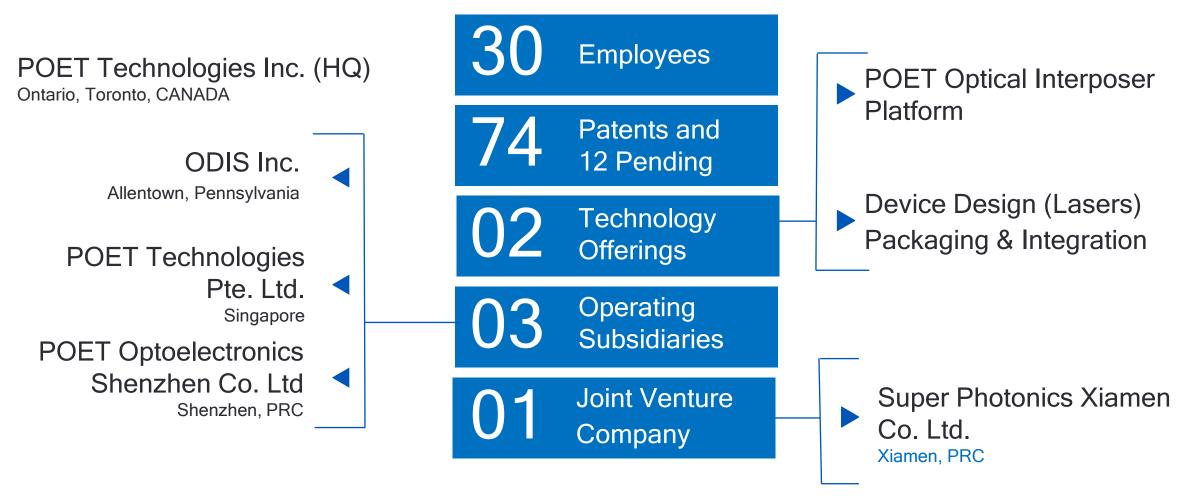
Mission: Establish an industry leadership position in chip-scale integrated photonics with validated disruptive, IP protected, Optical Interposer platform components for Datacenter, 5G and Co-packaged Optics

Building Blocks for Sustainable Growth





POET Technologies - Photonics Design & Development



Exchanges: TSXV: PTK OTCQX: POETF



POET Technologies Organization

CORP. HQ: TORONTO, CANADA FINANCE **INVESTOR RELATIONS CORPORATE ADMINISTRATION SINGAPORE** SHENZHEN, CHINA **SPX JOINT VENTURE** ALLENTOWN, PA **MANUFACTURING OPTICAL INTERPOSER PROCESS & OPTICAL ENGINE DESIGN & PRODUCT OPTICAL ENGINE DESIGN &** SALES DESIGN **DEVELOPMENT VALIDATION MODULE REFERNCE DESIGN & DEVICE DESIGN & PACKAGE DESIGN PLATFORM DESIGN APPLICATIONS ENGINEERING CUSTOMER TECHNICAL SUPPORT SUPPLY CHAIN RELIABILITY** (CHINA) **SUPPLY CHAIN & NPI RELIABILITY TESTING PRODUCT MANAGEMENT &** MARKETING **CUSTOMER TECHNICAL SUPPORT** (NORTH AMERICA, EUROPE)



Joint Venture for World Class Manufacturing and Scalability

- Super Photonics Xiamen POET and Sanan IC Joint Venture (JV)
 - Vertically integrated manufacturing for Optical Engines
 - Ability to rapidly scale production



Sanan IC | Xiamen Sanan Integrated Circuit Co., Ltd.

- Xiamen Torch High-Tech Industrial Development Zone
- US\$500 million investment on 180,000 square meters
- Compound semiconductor manufacturing platform
- Process technologies for microwave radio frequency, high power electronics & lasers



Sanan Optoelectronics Co. Ltd. (Parent)

- LED, filters, power electronics, microwave integrated circuits and optical comms.
- Produces 25 million 6" wafers per year with 4 locations and over 8,500 acres
- US\$1 billion Revenue; US\$14 billion market cap
- Shanghai Stock Exchange (600703)



Strategic Supply Chain

POET controls the supply chain to ensure performance, cost and delivery to customers

Optical Interposer

POET Owned and Designed



Photonic Devices

Strategic Sourcing
Co-Designed
POET Specified



Electronics

Off-the-Shelf or Customer Specified

Assembly & Test

Strategic Sourcing
Co-Designed
POET Specified





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What is Photonics and Why is Photonics Important?

Photonics devices create, detect and manipulate light. Laser generated light is fundamental to sensing, computing, data and telecommunications - the biggest trends in computing today

Proliferation of Cloud Computing



Data Centers
Network Switching

Growth of Artificial Intelligence



Neuromorphic Optical Computing

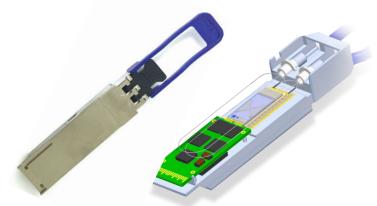
Adoption of 5G and Edge



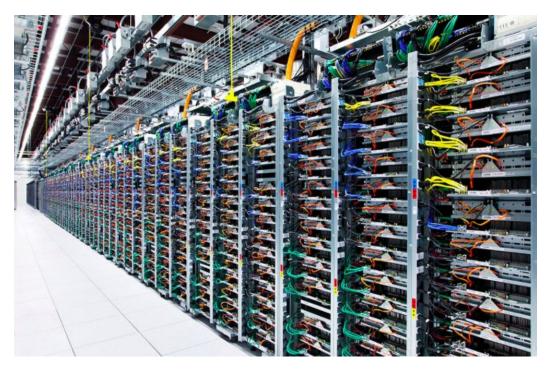
Communications Internet of Things



Photonic Transceivers Convert Digital Electric Signals Into Light Signals and Back Again







Photons and light waves compared to copper:

- 100X more data per second
- 10X lower power consumption
- 10X less heat produced



Conventional Approaches are Expensive and Slow

- Making reliable photonics devices are expensive in both capital and labor
 - Cost declines have not kept up with Moore's Law- most photonics modules are built individually
- Multiple different components must be able to interconnect seamlessly

Integration of components at wafer-scale has not been fully implemented even by the

largest companies working for the past 20 years

Photonics

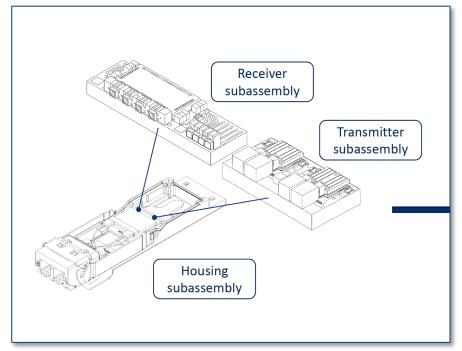
Lasers Detectors **Modulators** Multiplexers De-multiplexers Size Converters

Electronics

Controllers **Amplifiers** ASIC's **Monitors** Micro-processors Memory

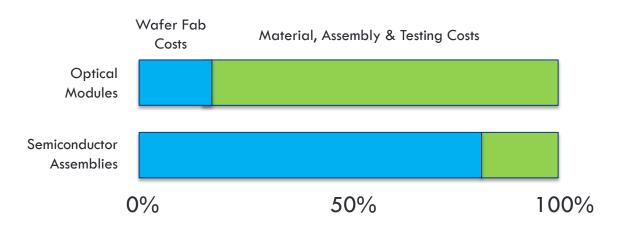
Optics

Mirrors Lenses **Prisms** Collimators **Polarizers Beam Splitters**





Why Integration Matters



- Materials, Assembly & Testing = 80% of total cost of an optical module, with the optical components and packaging representing => 70% of the total
- The opposite is true for semiconductors
- The only way to reduce optical module cost is to address the cost of optical components, materials, assembly and test.
- By applying proven wafer-scale semiconductor manufacturing techniques to achieve Integration, POET:
 - Dramatically reduces component cost
 - Improves size, power, cost, speed, reliability and scalability
 - **Enables new functionalities**

Breakdown of Optical Module Costs

Indirect Costs: 20%

Materials, Assembly & Test 80%

Total Cost 100%

Breakdown of Materials, Assembly & Test Costs

Electrical Components: 10%

Optical Components: 40%

Packaging: 50%

90% of Material, Assembly & Test Costs => 70% of Total Cost



POET's Approach

POET took on the dual challenge of INTEGRATION and PLATFORM to develop a unique, disruptive and differentiating new entry into photonics markets

Integration is the practice of combining different parts or functions so that they work together seamlessly

A **platform** is a group of technologies that are used as a base upon which other applications, processes or technologies are developed



A popular example of the combination of Integration and Platform Technology



From Platform to Products

"A product platform is not a product. It is a collection of **common elements**, especially the underlying core technology, implemented across **a** range of products."

Product Platform Strategy:

- defining product generations
- supporting extensions
- creating derivatives
- enhancing capability

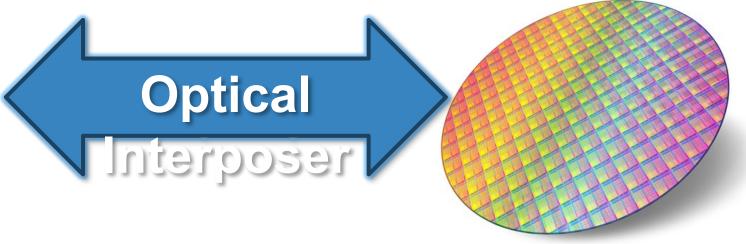




POET is doing for Photonics what Semiconductors did for Electronics - Achieving Lower Cost and Higher Performance through Device Integration and Wafer-Level Fabrication

The POET Optical Interposer™ is an **integration platform** that combines photonic, electronic and optical devices in the same chip-scale package - fabricated, assembled and tested all at wafer scale





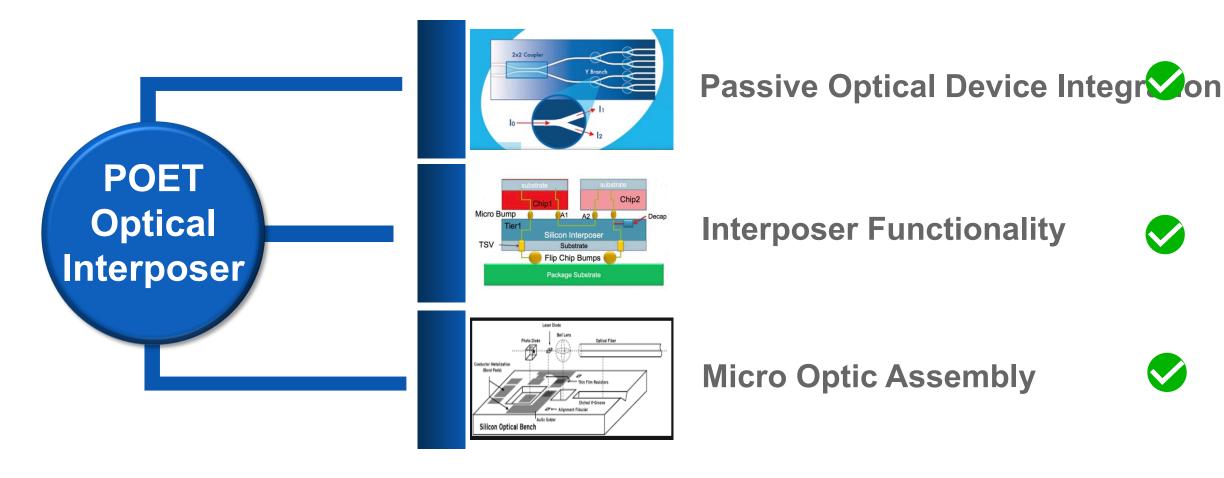


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POET's Optical InterposerTM Platform

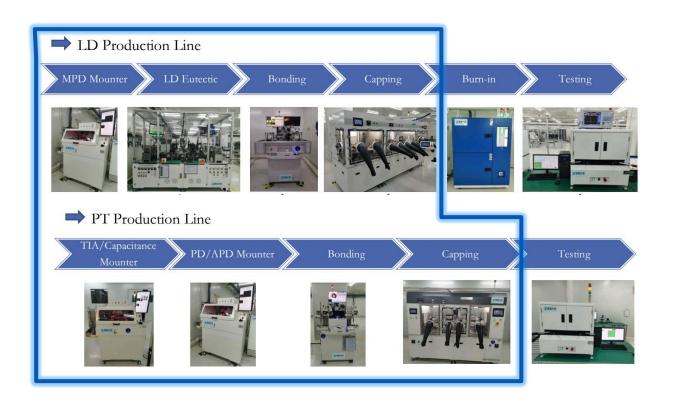
- A unifying hybrid optoelectronics WAFER SCALE integration platform







Rethinking Conventional Photonics Assembly





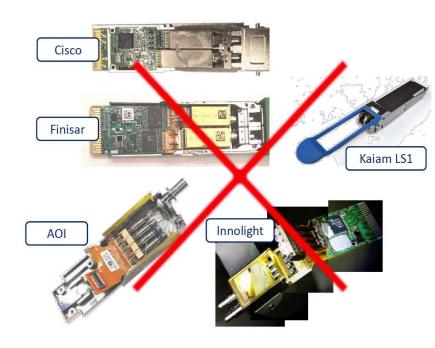
Reducing Components; Reducing Capital; Reducing Time



Rethinking the Optical Transceiver

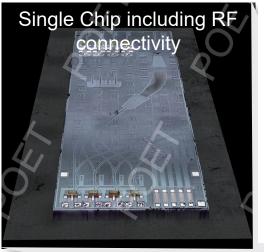
- Combining All Photonics / Optics Components into One Chip
- And building them hundreds at a time instead of one at a time, at wafer scale

Competing Technologies



- Discrete microoptics or
 TOSA/ROSA
 approach
- Lots of components, assembly and alignment
- Limited scalability: no space for high channel count products
- Limited cost scalability

POET

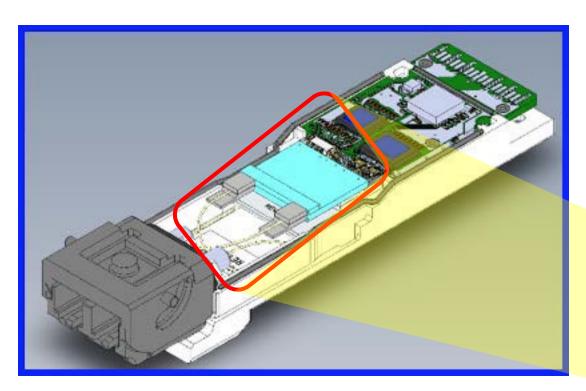


- Simpler BOM and reduced number of build/test steps
- Standard assembly technologies
- Scalable for future higher density products

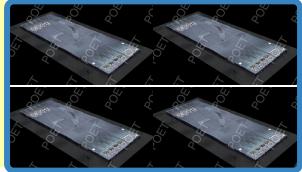


The World's Smallest and Lowest Cost 100G Optical Engine

4 x 25G DML Lasers, 4 High Speed Photodiodes, 4 Monitor Photodiodes, Mulitplexers, DeMultiplexers, Power Taps and Fiber Attach
 - all on a 9mm x 6mm POET Optical Interposer platform



FOUR POET Optical Engines can fit in a space occupied by one!!



How POET Wins:

- Simplified Packaging
- Lower Bill of Materials (BOM) Cost
- Highly Automated Wafer Scale Manufacturing
- Dense, Smallest Form Factor
- Excellent Electrical and Optical Performance



POET's Optical Interposer - Low Cost AND High Performance

The benefits POET's Optical Interposer add up to a truly disruptive entry into large-scale photonics markets

✓ Dramatically lower module cost	25% - 40% less
✓ Lower CAPEX investment for module assembly & test	1/10 th of others (discrete or SiPh PIC based)
✓ Chip-scale package	Reduces power consumption
✓ Wafer-level assembly and test	Built 100's at a time, not 1 at a time
✓ Planar architecture	Ease of production and flexibility in design
✓ Platform technology	Adaptable to multiple applications (e.g., 5G, AI, IOT)



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Product Roadmap driven by Customer Engagement

	2020	Q1 2021	Q2 2021	Q3 2021	Q4 2021	
100/200G CWDM4 Optical Engines		Pre-Alpha	Alpha	Beta	Production	
	Optical systems and module customer					
400G LightBar Engine	Pre-Alpha		Alpha	Beta		
Leading Optical systems customer						
400G FR4 Receiver		Pre-Alpha	Alpha	Beta	Production	
	Optical module custo	omer				
400G FR4/DR Tx Optical Engines				Pre-Alpha	Alpha	
	Multiple optical mod	lule customers				

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Market Application for POET's Optical Interposer

POET's Optical Interposer can lower the cost and improve the performance of any photonics device targeted at the highest growth areas of computing today and in the future

Proliferation of Cloud Computing & HPC



Data Centers
Network Switching

Growth of Artificial Intelligence



Neuromorphic Optical Computing

Adoption of 5G and Edge

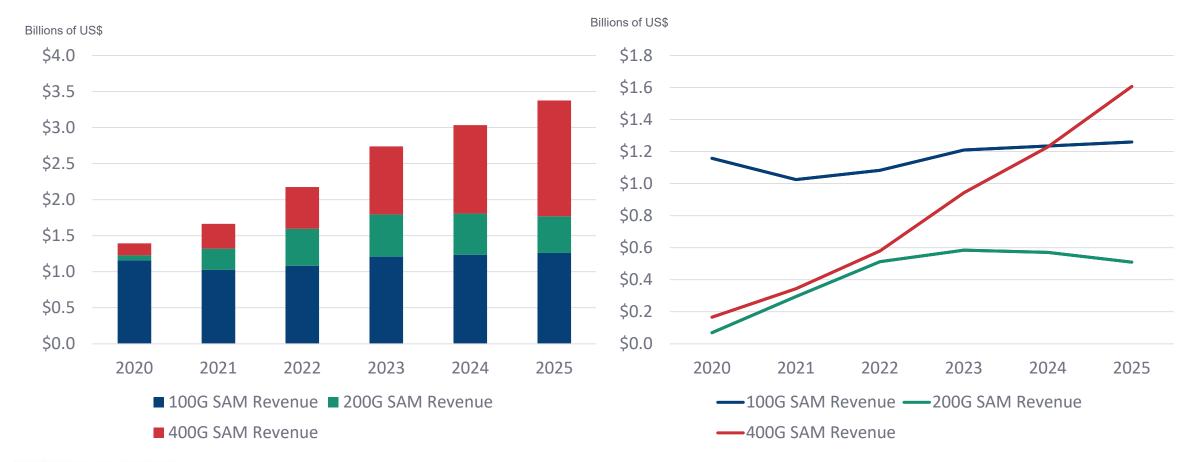


Communications Internet of Things



Initial Target Markets in Optical Transceivers

Serviceable Available Market (SAM) for 100G, 200G and 400G Optical Transceivers*
*does not include recently increased TAM estimates for 200GLR4





POET Potential Customers

Partial List of Potential Customers for Optical Engines for Optical Transceivers and for Co-Packaged Optics

Transceiv	er Module	Optical System	Cloud Data Center
ADVA	Accelink	Cisco	AWS
Delta	Cloudlight	Huawei	Google
Molex	GigaL	Juniper	Facebook
Eoptolink	HG	Acacia	AliBaba
Hisilicon	Huali	Arista	
Source	Xgiga	Nokia	
Hisense	Hengtong		



POET Opportunity

	Transceivers for Datacom	5G Networks	Co-Packaged Optics	Optical Computing and Edge Applications
Market Size SAM (peak 2021-28) :	\$2-3.5B annually	\$3-5B annually	\$2-3B annually	\$3-5B annually
Development Partners:	Tier 1 NA European	Several in play	Several in play	US-based Start-up
JV / Assembly & Test Partner(s):	Sanan IC JV SuperPhotonics	Sanan IC JV SuperPhotonics	TBD	TBD
Potential Customers:	Multiple module makers	Multiple module makers	Cisco Arista Juniper	Nvidia HPE
Revenue Potential:	\$250M+ annually	\$250M+ annually	\$250M+ annually	\$250M+ annually



Summary

- POET successfully transitioned from technology development to product development in the second half of 2020
- Data from prototype devices assembled at wafer-scale showing performance that exceeds internal expectations
- Super Photonics Xiamen provides ability to meet customer demand and to scale rapidly
- POET has an opportunity to build a \$1 Billion annual revenue business in just the 4 application areas that we are working in today



